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Influence of trivalent Cr ion substitution on the physicochemical, optical, electrical, and dielectric properties of sprayed NiFe₂O₄ spinel-magnetic thin films

 Apparao R. Chavan,^{*ab} Sandeep B. Somvanshi,^{ID *b} Pankaj P. Khirade^{ID *c} and K. M. Jadhav^{ID *b}

In this study, we mainly investigated the effects of trivalent Cr ion substitution on the properties of nickel ferrite (NCF) spinel-thin films. The as-prepared spinel thin films were characterized by thermogravimetry-differential thermal analysis (TGA-DTA) to comprehensively examine their phase transition. X-ray diffraction (XRD) analysis revealed that the prepared films have a single-phase face-centered cubic crystal structure. A Raman study confirmed the arrangement of the inverse-cubic spinel structure of these spinel-thin films. Field-emission scanning electron microscopy (FE-SEM) images verified the slight agglomeration of particles. Similarly, transmission electron microscopy (TEM) images together with selected area electron diffraction (SAED) patterns supported the XRD results. PL spectra showed enhanced near band emission (NBE) intensity due to the passivation of oxygen vacancies by Cr³⁺ substitution. The DC electrical resistivity (ρ) increases from $1.4 \times 10^{-6} \Omega \text{ cm}$ to $4.42 \times 10^{-6} \Omega \text{ cm}$ at room temperature. Dielectric parameters were studied as a function of frequency in the range of 1–10 MHz at 300 K, and these parameters decreased with the increasing Cr³⁺ ion concentration in the spinel-thin films. The obtained results indicate the applicability of the fabricated thin films in high-frequency electronic devices.

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1. Introduction

Recently, nanoscale spinel structured ferrites have attracted the interest of scientists and technologists due to their significant physicochemical properties and broad applicability in magnetic storage systems,¹ high-frequency devices,² magnetic switches,¹ nano-photo-catalysis,^{3,4} nano-fluid systems,⁵ spintronic devices,⁶ ferrofluids,⁷ bio-separations,⁸ drug delivery,⁹ and magnetic hyperthermia.^{10,11} At the nano-scale, ferrites with higher surface areas possess prominent magnetic and electrical properties over their bulk forms.¹² Nano-spinel ferrites have the typical formula of 'AB₂O₄', where the 'A²⁺' and 'B³⁺' ions respectively possess 'tetra (-A-)' and 'octa [-B-]' sites.^{13–15} The oxygen ions form a cubic structure with the iron ions situated at two distinct interstices between them: tetra (A) and octa [B] sites. Among the various types of ferrites, spinel ferrites represent a significant set of dedicated magnetic materials and have been broadly applied in

computer memories, rationale gadgets, transformer-cores, recording plates, radio wire poles, stacking loops, bio-applications, and microwave gadgets.^{16–19} Ferrite thin films are a potential candidates for numerous electrical and electronic devices. Ferrite thin films are appealing materials owing to their fixed magneto-electric properties and high synthetic dependability, which are valuable for some applications, for example, magnetic recording media, magnetic and gas sensors, and microwave gadgets.^{20–23} Ferrite thin films are being broadly considered by numerous scientists to examine their deposition and growth mechanism and structural, optical, magnetic, and electrical properties.

Among all the spinel ferrites, nickel ferrite (NiFe₂O₄) is a high-quality candidate for technological applications, and its unique macroporous films can open up new opportunities for a wide range of advanced applications.^{24,25} Nickel ferrites in a thin-film form are of prime interest due to their superior magnetic, electrical, and dielectric properties with greater chemical steadiness and lower magnetic loss factor at high frequencies.²⁶ They have an irregular spinel structure and are malleable magnetic materials with a spinel-inverse structure.²⁷ Nickel-ferrite thin films in the nanocrystalline form are applicable for use in memory gadgets,²⁸ sensors,²⁹ catalysis, and diverse applications.³⁰ Gunjekar *et al.*³¹ have prepared the ferrite

^aDepartment of Physics, Sir Parashurambhau College, Pune (MS), 411030, India. E-mail: 2020chavan@gmail.com

^bDepartment of Physics, Dr Babasaheb Ambedkar Marathwada University, Aurangabad (MS), 431004, India. E-mail: sbsomvanshi1993@gmail.com; drjadhavkm@gmail.com

^cDepartment of Physics, Shri Shivaji Science College, Amravati (MS), 444603, India. E-mail: pankajkhirade@gmail.com



thin films of nickel onto a glass substrate utilizing a synthetic strategy. The XRD patterns of these films demonstrated the formation of a nano-sheet along the (311) plane. Microstructural investigation of these thin films indicated a sheet-like structure with an average thickness of 30 nm. To obtain precision in the performance of thin film-based gadgets, control over the film properties is essential. Sredojevic *et al.*³² have conducted initial and other examinations on Ni-Fe thin films by a spin-coating strategy. Pawar *et al.*³³ have investigated the impact of Cr³⁺ substitution on the structural and other properties of NiFe₂O₄ films *via* physical techniques. The XPS results proposed that Ni²⁺ and Fe³⁺ particles exist in tetra sites just as in octa sites, and the immersion charge radically drops when compared with that for the reverse spinel structure. Along these lines, a few endeavors have been made by researchers to deposit ferrite thin films by various procedures. The physical methods comprise pulsed laser deposition and RF sputtering,^{34,35} whereas the chemical techniques include spray pyrolysis, chemical vapor deposition, and chemical bath deposition.^{23,36} However, physical methods, such as pulsed laser deposition, have the merit of providing control over the film development and thereby over each parameter of the thin film. Similarly, wet chemical techniques are being significantly considered by numerous analysts for the preparation of thin films because they are facile and economic and require low temperatures. Many wet chemical methods, specifically substance spray pyrolysis, sol-gel process, spin coating, and so forth, are generally used for the deposition of the thin films of spinel ferrites.^{37–40} Among the few wet chemical techniques, spray pyrolysis has some merits because of its simple experimental setup and cost-effectiveness. This technique is generally applicable for the generation of ferrite thin films with a more significant surface area with consistent thin film layer formation. Spray pyrolysis is a fundamental chemical deposition technique in which fine droplets of the solution containing stoichiometric metal ions is sprayed on preheated substrates, which is glass in most of the cases.⁴¹ Thermal decomposition takes place on the glass substrates, bringing about a thin film layer formation in thin film.

As indicated by a literature overview, nickel ferrite is an inverse spinel ferrite in which nickel ions are present at octahedral sites. Moreover, Fe³⁺ ions are similarly disseminated amongst the tetrahedral (A) and octahedral [B] sites.²³ The presence of non-magnetic particles, such as Cr³⁺, instead of magnetic iron ions can offer fascinating changes in electrical properties as like as magnetic properties. In the literature, many studies have been reported on the fabrication and investigation of the magneto-electric properties of nickel ferrite in the thin film form. However, to the best of our knowledge, to date, no study has been reported on Cr³⁺ impurity-substituted nickel ferrite thin films. Herein, we report Cr³⁺-substituted nickel ferrite thin films, with the matrix equation NiFe_{2-x}Cr_xO₄ (for $x = 0.0–1.0$ in the step of 0.2), deposited on preheated (380 °C) silica glass substrates by the spray pyrolysis method followed by annealing at 550 °C for 2.5 h. Furthermore, the annealed films were characterized by standard techniques to determine the impact of Cr³⁺ ion substitution on the structural, thermal,

morphological, dielectric, electrical, and optical properties of these nickel ferrite thin films.

2. Experimental

A spray pyrolysis strategy was employed to fabricate the thin films of NiFe_{2-x}Cr_xO₄ (for $x = 0.0–1.0$ in the venture of 0.2) (NCF) on silica glass plates (cleaned by an ultrasonication process). We have comprehensively reported the stepwise deposition process in a previous study.⁴² A schematic of the deposition of the NCF thin films on silica glass plates *via* the spray pyrolysis technique is depicted in Fig. 1. Thermogravimetric and differential thermal analysis (TGA-DTA) was employed to elucidate the thermal behavior of the typical as-deposited thin-film samples. The structural parameters of all the thin films were investigated by an X-ray diffractometer using 'Cu-K α ' rays in the 2θ range of 20–80°. Raman spectra were recorded at 300 K by a 'Micro-Raman Spectrometer'. The film thickness was estimated by a surface profiler. The surface morphology of the thin films was studied using field-emission scanning electron microscopy (FE-SEM) and transmission electron microscopy (TEM) accompanied by selected area electron diffraction (SAED). Elemental analysis was conducted

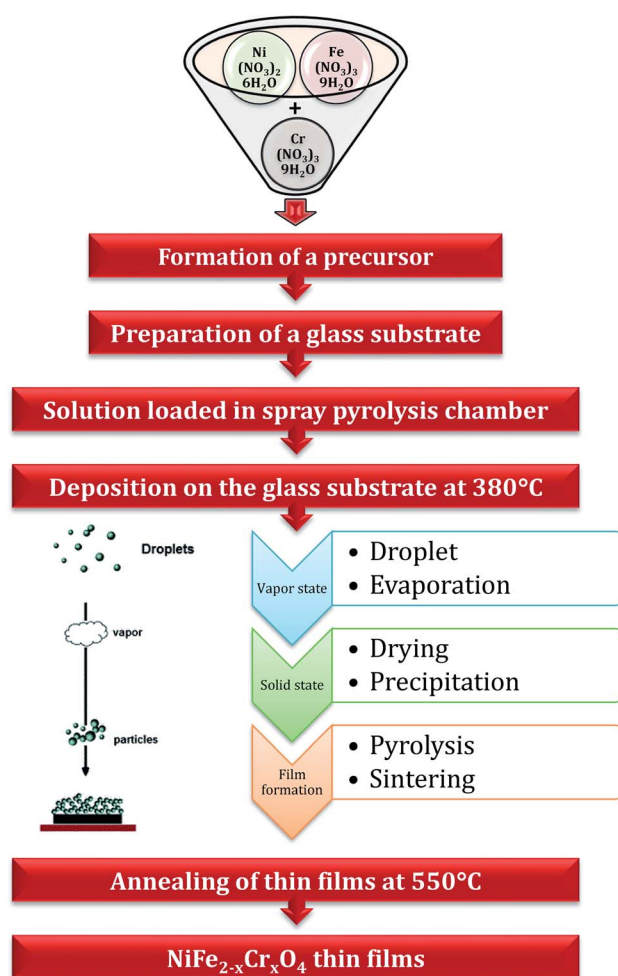


Fig. 1 Schematic of the deposition process of the NCF thin films.



by energy dispersive X-ray (EDAX) analysis. Herein, the four-probe technique was employed to obtain the DCR plot as a function of temperature in the range between 303 and 723 K. A dielectric study was performed to examine the dielectric parameters at 300 K as a function of frequency in the range from 1 to 1 MHz.

3. Results and discussion

3.1 Thermal analysis

The TGA-DTA plot for the growth procedure of the as-deposited thin-film samples of NiFe_2O_4 (continuous line) and $\text{NiFe}_{1.2}\text{Cr}_{0.8}\text{O}_4$ (dashed line) in the temperature range from 20 to 800 °C is shown in Fig. 2. The TGA curve starts to diminish from room temperature to 470 °C, which demonstrates a solitary real weight reduction of ~10%, and the concurrent DTA curve demonstrates the exothermic peak at 430 °C. An exothermic peak appears at 430 °C, corresponds to the weight reduction in the temperature range of 200 to 500 °C, and a little exothermic peak appears at 195 °C.⁴³

In the TGA curve, a decrement in the weight is observed at 320 °C because of water loss and a gradual crystallization process occurring from 470 to 800 °C in the thin film sample. The maximum weight reduction in the temperature range from 470 to 800 °C affirms the development of a crystalline and spinel structure. The most extreme weight reduction at 320–460 °C is due to the removal of water, contaminations, and nitrates and decay of the original mixes.^{44,45} At temperatures higher than 470 °C, the weight reduction remains constant. The same trend was observed for the $\text{NiFe}_{1.2}\text{Cr}_{0.8}\text{O}_4$ sample designated by a dashed line (Fig. 2). The TGA curve demonstrates that the rate of weight loss is nearly constant above 470 °C. Therefore, the annealing temperature of 550 °C was used for all the resultant NCF samples.

3.2 X-ray diffraction

The XRD patterns of the NCF thin-film samples are depicted in Fig. 3(a). All the obtained XRD patterns demonstrate diffraction peaks corresponding to those of a cubic spinel structure, and

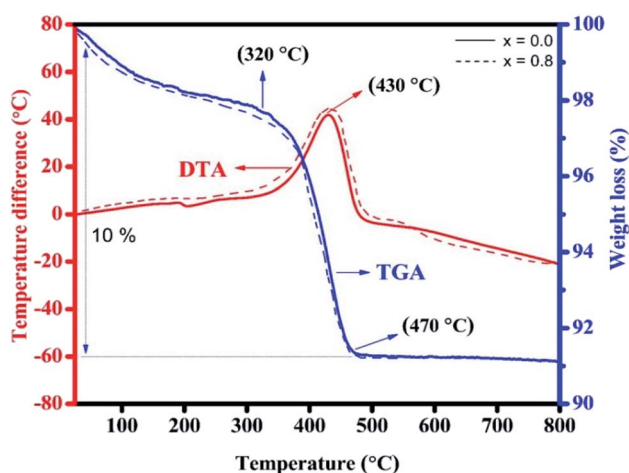


Fig. 2 The TGA-DTA curve of the as-prepared NiFe_2O_4 (continuous line) and $\text{NiFe}_{1.2}\text{Cr}_{0.8}\text{O}_4$ (dashed line) thin films.

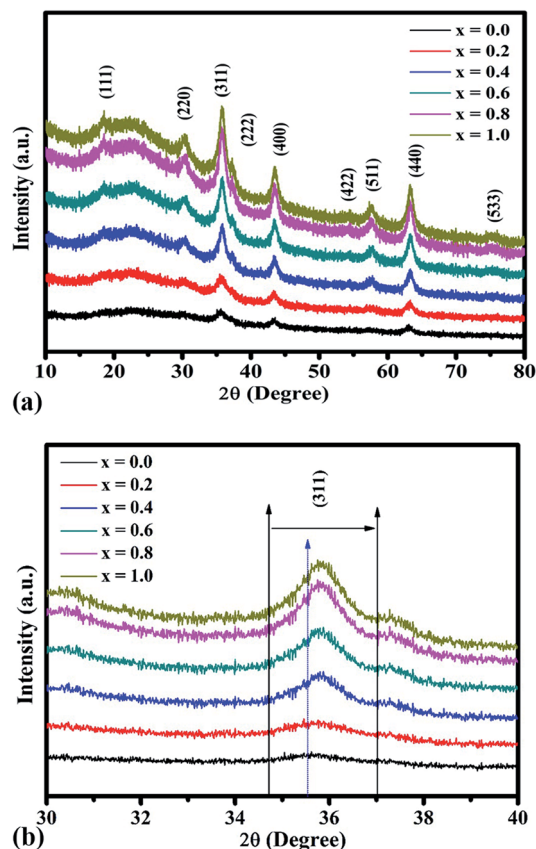


Fig. 3 (a) X-ray diffraction patterns of the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films. (b) Shifting of the most intense (311) peak of the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films.

a closer assessment of the XRD patterns of the samples demonstrates the absence of peaks related to other unwanted phases. Upon careful observation of the XRD patterns, the presence of small intensity peaks was noticed, which might be because of the small thickness of the prepared thin films. The diffraction peaks corresponded to the (111), (220), (311), (222), (400), (422), (511), (440), and (533) reflections of the mixed spinel-ferrites with cubic structure affirms high crystallinity of the films. The Debye-Scherrer formula was used to determine the average crystallite size (D) of the prepared samples:⁴⁶

$$D = \frac{0.89 \lambda}{\beta \cos \theta} \quad (1)$$

Table 1 Lattice constant (a), X-ray density (d_x), and average crystallite size (D) of the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films

Composition	a (Å), (± 0.10)	d_x (gm cm^{-3}), (± 0.01)	D (nm), (± 2.0)
0.0	8.3273	5.392	45.15
0.2	8.3233	4.096	35.38
0.4	8.3201	4.082	33.75
0.6	8.2990	4.096	29.34
0.8	8.2886	4.093	24.61
1.0	8.2780	4.091	23.56



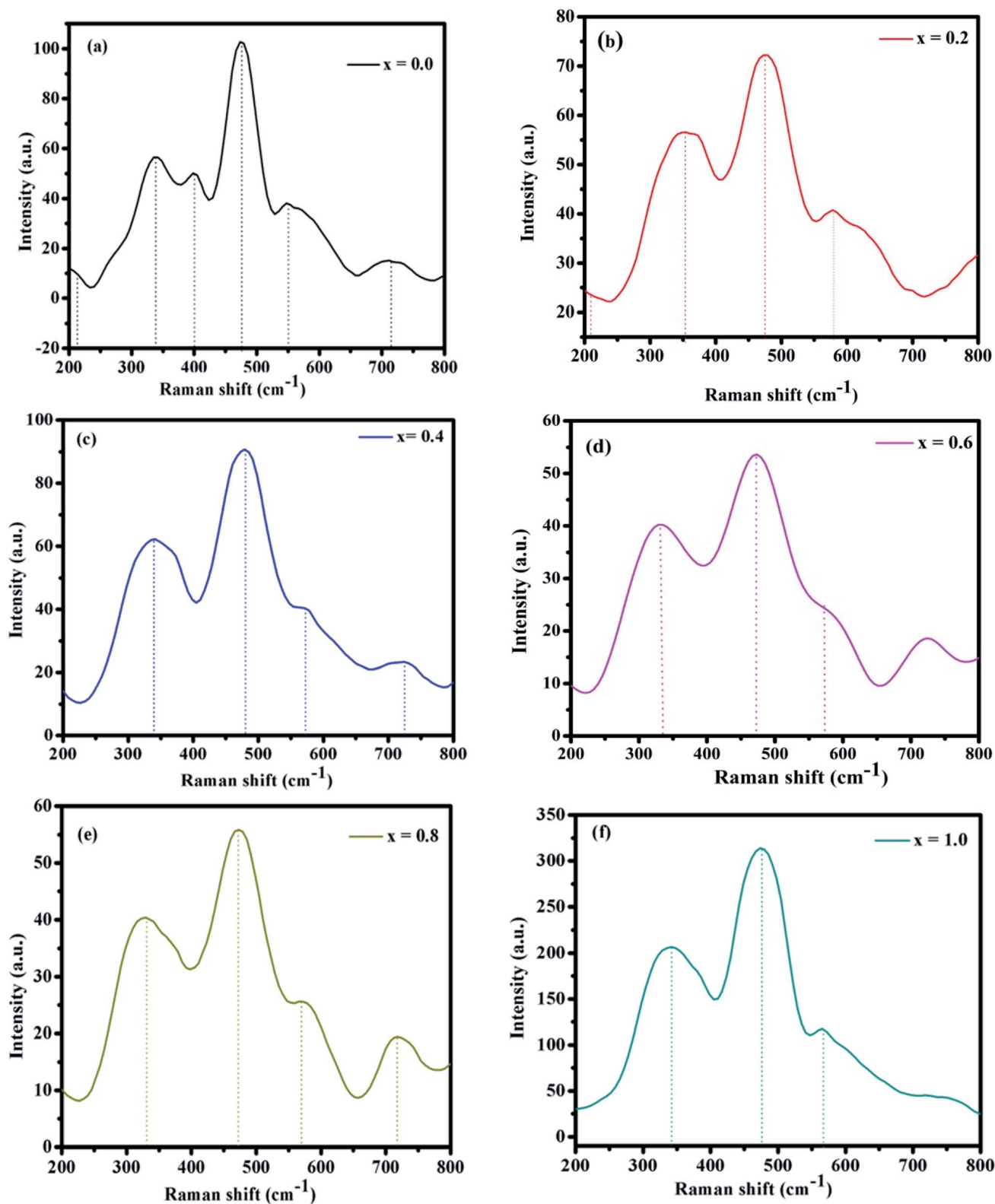


Fig. 4 (a–f) Raman spectra of the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films.

where λ is the X-ray wavelength and β is the line width at half the line intensity obtained by taking into account the instrumental broadening. The average crystallite sizes of the prepared thin films were in the range of 23.56–45.15 nm. In fact, the crystallite

sizes were decreased, as indicated by the induced strain and broadening peaks obtained with the substitution of the Cr^{3+} ion. The lattice parameter was calculated using the following relation.⁴⁷



Table 2 Raman spectra band position of the NiFe_{2-x}Cr_xO₄ thin films

Composition <i>x</i>	Assigned band position (cm ⁻¹)		
	'A _{1g} '	'E _g '	'3T _{2g} '
0.0	547	338	476
0.2	581	354	474
0.4	574	339	482
0.6	553	337	478
0.8	571	330	476
1.0	567	340	477

$$a^2 = \frac{\lambda^2(h^2 + k^2 + l^2)^{1/2}}{4 \sin^2 \theta} \quad (2)$$

where θ is the Bragg's angle and (hkl) are the Miller indices of the planes. The peak (311) moved towards higher 2θ angles, as shown in Fig. 3(b). The concentration of the Cr³⁺ ions increases, affirming a decrease in the lattice constant from 8.2780 to 8.3273 Å. The reduction in the lattice parameter values is because of the lower ionic radius of the Cr³⁺ ions (0.63 Å) when compared with that of the Fe³⁺ ions (0.67 Å). The X-ray density of the NCF thin films has been determined from the molecular weight and unit cell volume using the following relation:⁴⁸

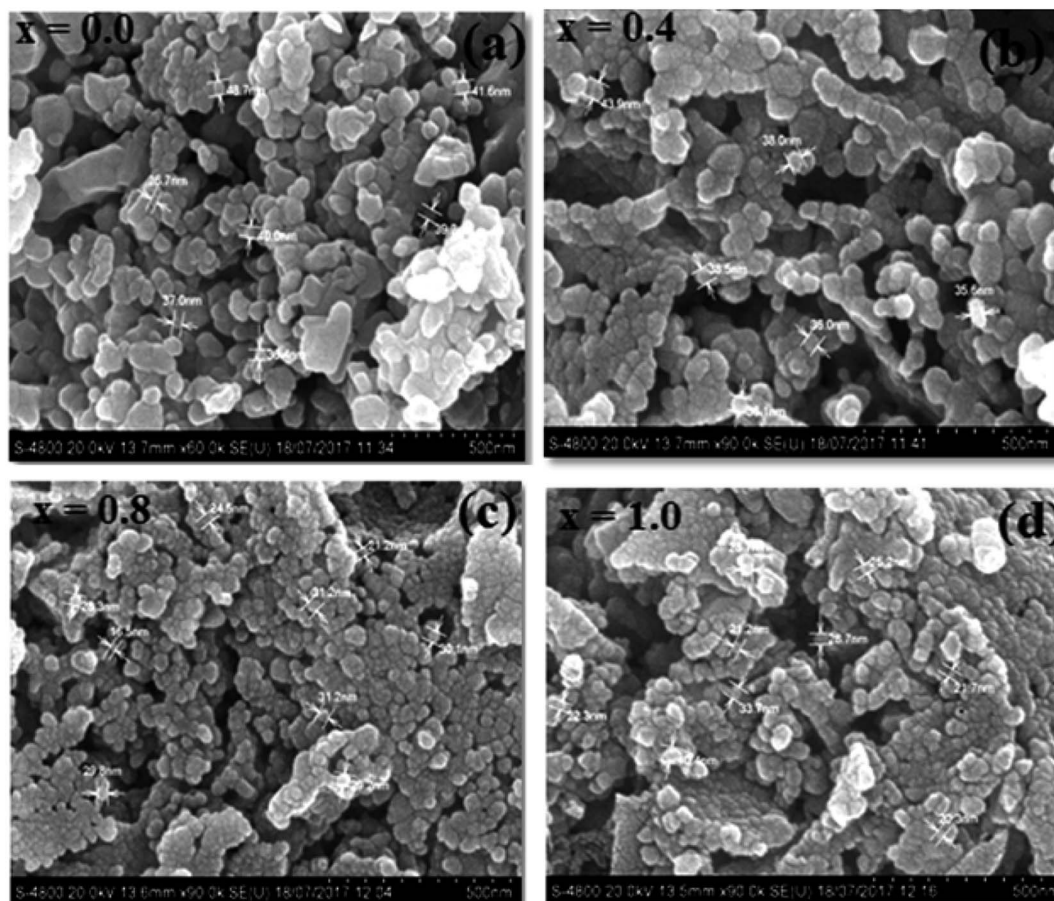
$$d_x = \frac{8 M}{N_A a^3} \quad (3)$$

where N_A is the Avogadro's number and a is the lattice parameter of the NCF samples. The values of the structural parameters, such as lattice constant and X-ray density, are presented in Table 1. The X-ray density decreases with the increasing substitution of the Cr³⁺ ions; this is due to the substitution of the Cr³⁺ ions with a smaller molar mass (51.996 g mol⁻¹) for the Fe³⁺ ions with a larger molar mass (55.845 g mol⁻¹).

3.3 Raman spectroscopy

The room-temperature Raman spectra of the NCF samples in the wavelength range of 200–800 cm⁻¹ are shown in Fig. 4(a–f). The Raman spectra of the ferrite with a spinel lattice structure having the space group 'Fd $\bar{3}m$ ' specifically revealed five active Raman modes: 'A_{1g} + E_g + 3T_{2g}'. The 'A_{1g}' mode is generated because of the symmetric extension of the 'O²⁻' ions next to the 'Fe–O' and 'Ni–O' bonds in the 'tetrahedral' sites. The 'E_g' mode originates from the symmetric twisting of the 'O²⁻' ions as for the metal ion.⁴⁹

In nickel ferrite, the 'octahedral site' is occupied by Fe³⁺ and Ni²⁺ ions, and the 'tetrahedral site' is accommodated by only Fe³⁺ ions. For all the thin-film samples, the Raman signals in the range of 540–585 cm⁻¹ correspond to the A_{1g} modes, which indicate extending vibration of Fe³⁺ or O²⁻ ions at the octahedral site.⁵⁰ The vibrational groups in the range 330–355 cm⁻¹ corresponds to the E_g whereas, the bands in the range 470–480

Fig. 5 (a–d) FE-SEM images of the NiFe_{2-x}Cr_xO₄ thin films.

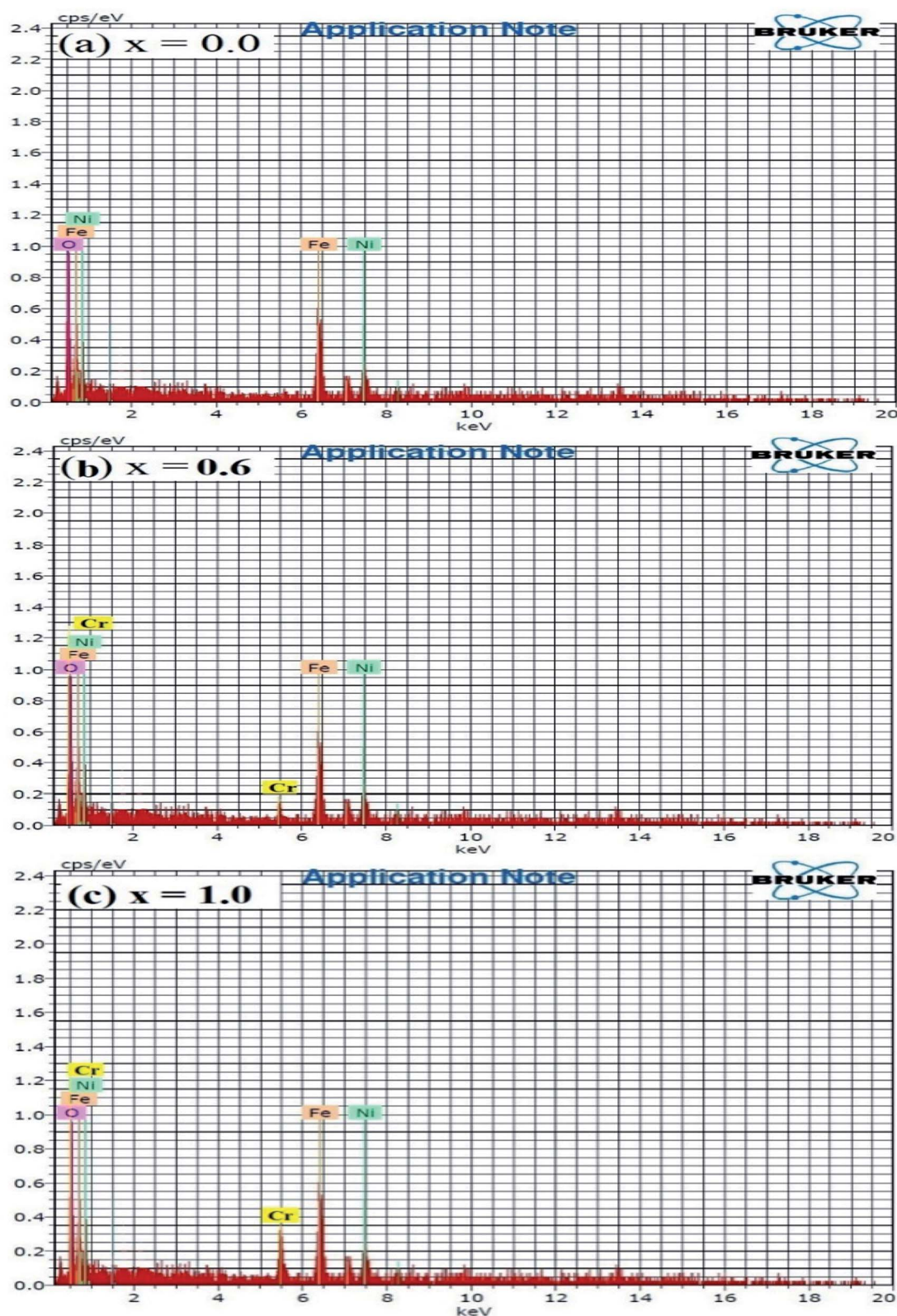


Fig. 6 (a–c) The typical EDAX spectra of the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films.

cm^{-1} corresponds to $3T_{2g}$ symmetry which is because of O^{2-} extending at 'octahedral' locales. The cation relocation in spinel NiFe_2O_4 changes because of the shifting of the metal ions from

the tetra site to the octa site.⁵¹ These site cation movements must break the extended cationic order and nearby disorder at both the tetra and the octa site sub-cross sections in the



meantime. Therefore, the outcome obtained from Raman scattering demonstrates the presence of a confined disorder instigated by cationic relocation in the NiFe_2O_4 thin films, which is affirmed by the XRD patterns. The Raman spectra band positions for all the samples are shown in Table 2.

3.4 Microstructural and compositional analysis

The FE-SEM images of the NCF thin-film samples are depicted in Fig. 5(a–d). The development of soft agglomerated particles demonstrates that the grains have a practically circular and regular shape. The magnetic dipole interaction in-between the grains loaded towards the agglomerating nature of the nanoparticle with expanding Cr^{3+} substitution content. The Cr^{3+} ion substitution profoundly influences the morphology, shape, uniformity, homogeneity, and distribution of grains.⁵² Fig. 5(a–d) show the representative FE-SEM images of typical

$\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ (0.0, 0.4, 0.8, and 1.0) thin films. The grain size (G) values were found to diminish with an increment in the Cr^{3+} ion concentration in the NCF samples; this suggests the growth of the crystallites. This decrement is credited to the accommodation of Cr^{3+} ions in the accessible sites amid particle growth, accordingly constraining the nucleation procedure and size. All the synthesized thin-film samples exhibit granulated sand-like grains.⁵³ The evaluated grain size is roughly in the range from 26.65 to 42.14 nm. The particles are sharp and significantly circular, demonstrating crystallinity, as affirmed by the XRD patterns. With a decrease in the film thickness, the grain size diminished and the films became compact and dense.^{54,55}

The elemental compositions of representative NCF thin films characterized by the EDAX technique are shown in Fig. 6(a–c). The EDAX technique was employed to approve the accuracy and purity of the chemical compositions. The desired peaks corresponding to Ni^{2+} , Cr^{3+} , Fe^{3+} , and O^{2-} was observed

Table 3 Elemental and atomic weight percentages (%) obtained from the EDAX of the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ ($x = 0.0, 0.4, 0.8,$ and 1.0) thin films

x	G (nm), (± 2)	Elemental weight (%)					Atomic weight (%)				
		Ni^{2+}	Fe^{3+}	Cr^{3+}	O^{2-}	Total (%)	Ni^{2+}	Fe^{3+}	Cr^{3+}	O^{2-}	Total (%)
0.0	42.14	27.3	34.86	0.00	37.84	100	11.94	19.16	0.00	68.9	100
0.2	40.13	27.11	29.14	5.46	38.29	100	11.63	14.68	7.55	66.14	100
0.4	34.64	26.58	22.06	10.33	41.03	100	10.93	11.41	11.08	66.58	100
0.6	33.12	28.12	16.45	18.36	37.07	100	10.24	7.9	17.68	64.18	100
0.8	28.58	26.85	9.84	24.46	38.85	100	11.91	3.81	23.23	61.05	100
1.0	26.65	28.1	6.12	22.66	43.12	100	11.65	1.92	21.57	64.86	100

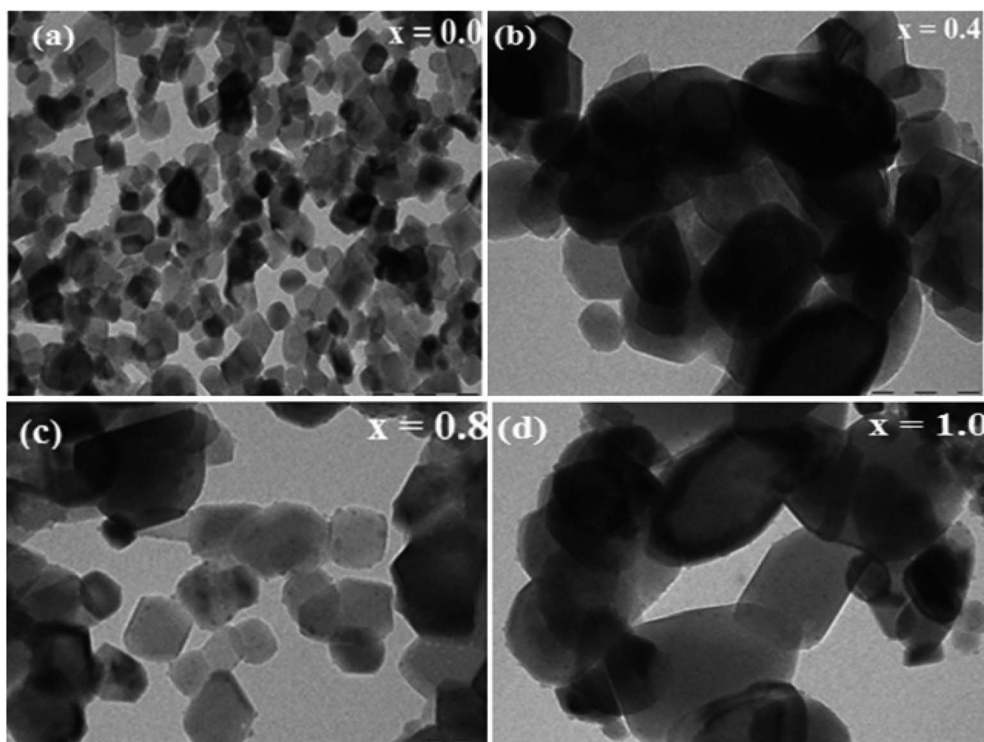


Fig. 7 (a–d) Typical TEM images of the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ (0.0, 0.4, 0.8, and 1.0) thin films.



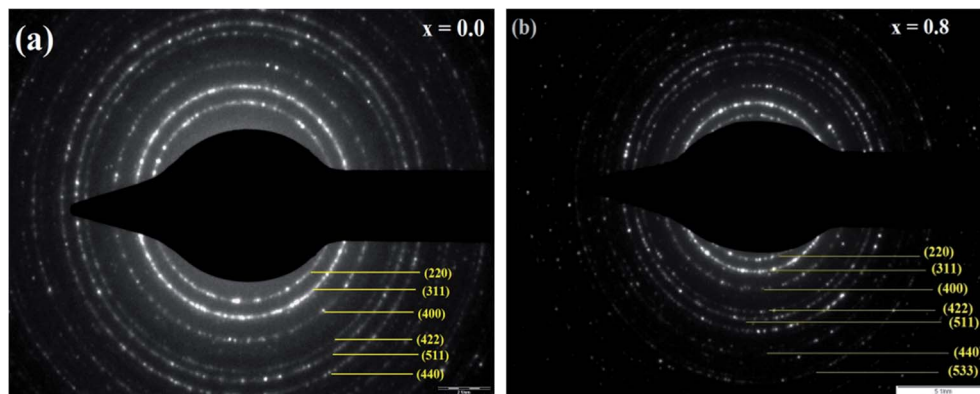


Fig. 8 (a and b) Typical SAED patterns for the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films with $x = 0.0$ and $x = 0.8$.

in the EDAX spectra and no impurity peak was observed. The atomic weight (%) and elemental weight (%) of the different components present in the NCF samples are in close agreement with the nominal compositions (Table 3).

Fig. 7(a–d) show the TEM images of the typical NCF samples ($x = 0.0, 0.4, 0.8$, and 1.0) of the prepared thin films. The TEM images demonstrate that the nanoparticles of the film samples obtained without a surfactant have a cube-like structure and uniform particle size and surface morphology.⁵⁶ The TEM images show that the significant agglomeration is because of the magnetic nature of the nanoparticles when compared with the observation made from the FE-SEM images.

The SAED patterns of the NCF thin films ($x = 0.0$ and 0.8) are shown in Fig. 8(a and b). They depict well-observed diffraction rings, indicating good crystallinity and single phase of the NCF thin films. Basically, the SAED patterns showing the high intensity (311) peak represents the cubic spinel structure and d -spacing of the NCF ($x = 0.0$ and 0.8) thin films. Each diffraction spot ring matches with the (d_{hkl}) spacing and indicates that the NCF samples are well-crystallized, which is consistent with the XRD outcomes.^{57,58}

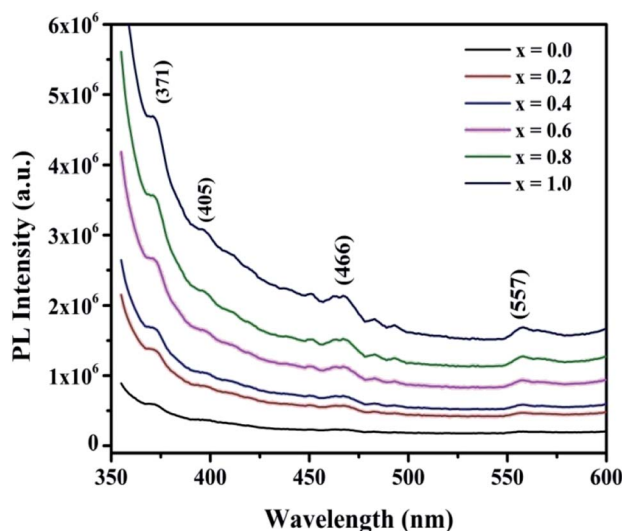


Fig. 9 Photoluminescence spectra of the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films.

3.5 PL spectroscopy

The room-temperature photoluminescence spectra of the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films in the range of 350–600 nm are depicted in Fig. 9. As observed, the PL spectra of the NCF samples possess a peak in the broader emission range of 350–600 nm with a band gap energy of 1.82–3.55 eV. This peak is due to the re-grouping of the charges, which happens because of lattice intrinsic defects and profound traps of the restricted surface position.⁵⁹ Nickel ions are present in the ‘octal’ sites, and iron ions are present in the ‘tetra’ sites; moreover, they have the electronic arrangements $3d_8$ and $3d_5$. The PL emission spectra were acquired using 400 nm as the excitation wavelength. The peak situated between 405 and 466 nm corresponds to the near band emission (NBE), which is due to the changes from ${}^3\text{A}_2({}^3\text{F}) \rightarrow {}^3\text{T}_1({}^3\text{P})$ and ${}^3\text{A}_2({}^3\text{F}) \rightarrow {}^1\text{T}_2({}^1\text{D})$.⁶⁰ The peaks at 371 nm and 466 nm correspond to the ${}^3\text{d}^5 \rightarrow {}^3\text{d}^4$ conversion of Fe^{3+} , which leads to electron excitation towards the conduction band.

The defect level emission (DLE) was obtained from the peak at 557 nm. It can be ascribed to the defects, such as oxygen vacancies, in the crystal structure and surface defects. The broader band from 540 to 560 nm is due to the transitions of the Ni^{2+} ions and $\text{Fe}^{3+}/\text{Cr}^{3+}$ ions.⁶¹ The intensity of the NBE

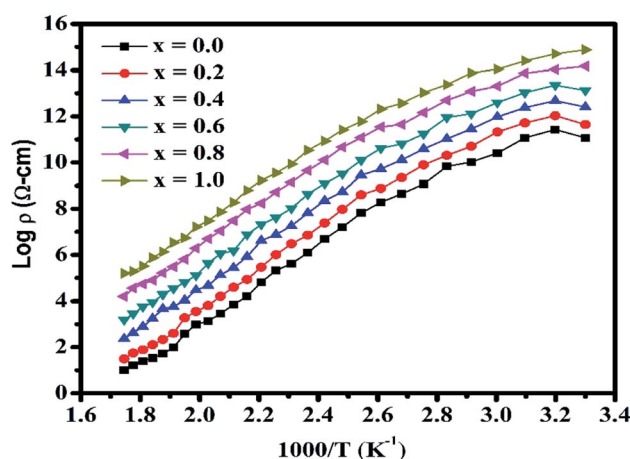


Fig. 10 DCR plots for the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films.

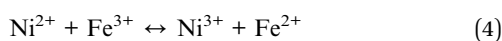


increases with the increasing Cr³⁺ ion concentration in the NCF samples. This means that the reductions in the oxygen vacancies cause a reduction in the number of photogenerated electrons in the NCF thin films.⁶² The PL range demonstrates the presence of Ni²⁺ ions at both the octal and tetra sites, confirming the assorted spinel lattice structure of these films.

In the PL spectra, it can be clearly noticed that from $x = 0.0$ to $x = 1.0$, the PL emission intensity increases. As the sample is a deposited thin film (thickness: ~ 250 – 300 nm), in the case of 400 nm excitation, the penetration depth of one-photon excitation is around ~ 300 nm;⁶³ hence, it can deeply penetrate the sample. Therefore, the observed PL spectra may have originated from the substrate as well, and subsequently, a wide background appears. Moreover, the PL intensity increases from $x = 1.0$ onwards; this means that now the excitation energy normalizes towards the bandgap of the material. In this case, under resonant pumping, there is a probability of the excitation of more molecules to the conduction band, and hence, the emission is enhanced. Under the resonant condition, all molecules are excited, and the saturation of linear absorption further results in the formation of emission.

3.6 Electrical properties

The variation in the DC electrical resistivity (DCR) *versus* temperature (323–723 K) for the NCF samples is shown in Fig. 10. Fig. 10 reflects that the resistivity significantly diminishes with an increment in temperature because of the hopping of electrons, which shows a semiconducting nature of the films.⁶⁴ The Verwey and Bohr's system can clarify the conduction procedure in the NCF samples. During the deposition and annealing process, iron and nickel ions are generated in a small amount, and electron exchange occurs between the Fe³⁺ and Ni²⁺ ions, which can be represented as follows:



In the current investigation, the plot of $\log \rho$ *versus* $1000 \times T^{-1}$ shows the variation in slope, which makes two distinct regions namely paramagnetic region and ferromagnetic region. The variation in resistivity as a function of temperature confirms the Arrhenius relation.⁶⁵ Using the DCR plots, the activation energy ΔE for each sample in the ferrimagnetic and paramagnetic locale was determined. The estimated activation energies for the all Cr³⁺-substituted nickel spinel ferrite samples are presented in Table 3. The estimated activation energy ' ΔE ' values of the samples under investigation were observed to be in the range from 0.42 to 0.26 eV. In Fig. 10, it can be clearly noticed that the resistivity diminishes with the increasing temperature. This might be due to the presence of Fe³⁺ in the [B]-site. Notably, the conductivity of ferrite depends on the proportion of Fe³⁺ to Fe²⁺ since this proportion diminishes with the increasing concentration of Cr³⁺ ions; at this point, resistivity should show a constant decline with the increasing concentration of Cr³⁺ ions.

Electrical conduction in spinel ferrite arises due to the electron bouncing in between the ion pairs of a similar element located at distinct sublattices with difference valence state. The quantity of these ion pairs relies on the sintering circumstances

Table 4 DC electrical resistivity (ρ), activation energy (ΔE), and thickness (T) of the NCF thin films

x	ρ (Ω cm) $\times 10^6$	ΔE (eV)	T (nm)
0.0	1.40	0.42	277
0.2	1.62	0.38	265
0.4	2.30	0.34	256
0.6	2.80	0.29	248
0.8	3.64	0.27	283
1.0	4.46	0.26	287

and degree of decrease of Fe³⁺ \leftrightarrow Fe²⁺ at a raised temperature. The proportion of Fe²⁺/Fe³⁺ at the [B]-sites controls the general resistivity in ferrite materials.⁶⁶ The breaking of the DCR plots in two areas of conductivity affirms the temperature associated with the Curie temperature (T_c) of the samples. The lower temperature area underneath the Curie temperature is related to the arranged ferromagnetic area having a little ΔE , whereas the superior temperature locale over T_c corresponds to a paramagnetic area with relatively high activation energy.^{67,68} A sharp and huge increment in resistivity at low concentrations of the dopants is very evident, whereas the expansion is less articulated for higher concentrations. However, direct magnetic loss estimations in a wide frequency range and their complete analysis are required to thoroughly address the pertinence of Cr³⁺-substituted nickel ferrite materials for microwave applications (Table 4).

3.7 Dielectric parameter studies

The dielectric properties of spinel ferrite thin films firmly rely upon a few variables including the deposition procedure, chemical composition, grain structure, stoichiometry, percentage porosity values, the charge of ions, grains size, and cationic dissemination among the interstitial sites. Dielectric parameters are beneficial for the absorption of electromagnetic waves.^{69–72} Fig. 11(a) shows the variation of the real part of the dielectric constant *versus* frequency for the as-prepared Cr³⁺-substituted nickel ferrites with various compositions. The dielectric constant (ϵ') is enhanced in the lower frequency range and diminishes with the increasing frequency. There are diminishing pattern in the least value with the increasing frequency,⁷³ which shows the typical behavior of 'ferromagnetic' materials. The higher dielectric constant at lower frequencies might be because of the simultaneous presence of various types of polarization contributions of space charges and further it starts to diminish with an increase in frequency.⁷⁴ As per the Koop's hypothesis, the decrease in the dielectric constant with the increasing frequency is because, at higher frequencies, several factors impact the polarization to indicate change in the functional field. The dielectric constant (ϵ') was determined utilizing the following formula:⁷⁵

$$\epsilon' = \frac{C_p t}{\epsilon_0 A} \quad (5)$$

The decrease in dielectric constant was observed due to the electrical polarization. The present examinations demonstrated



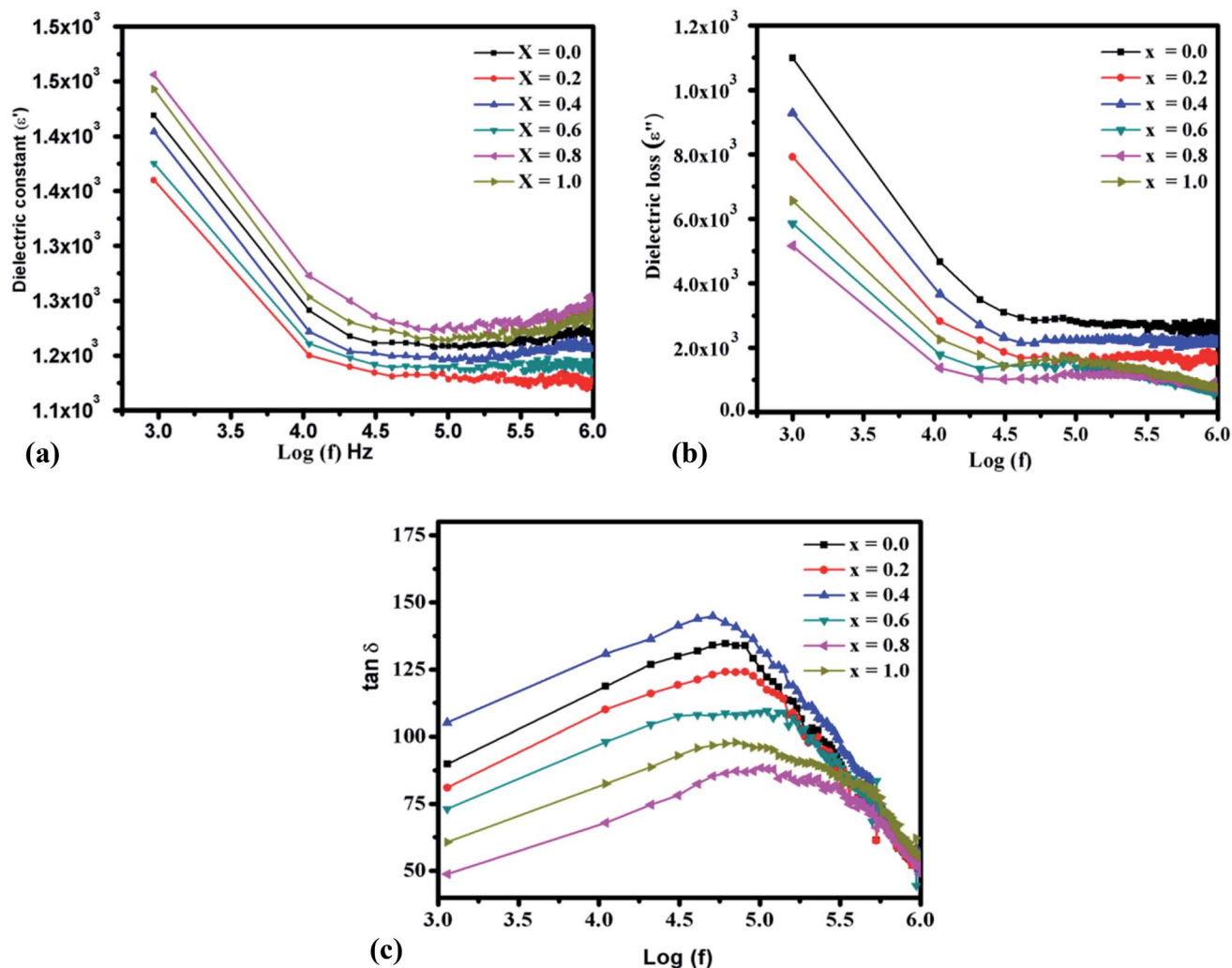


Fig. 11 (a) Variation of dielectric constant for the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films. (b) Variation of dielectric loss for the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films. Variation of the dielectric loss tangent for the $\text{NiFe}_{2-x}\text{Cr}_x\text{O}_4$ thin films.

that the dielectric constant (ϵ') of the NCF samples is higher than that of the pure nickel ferrite thin film. The reason behind these variations might be the concentration of Cr^{3+} ions, which decreases the hopping of the electrons over grain boundaries.⁴⁹ The reduction in the dielectric constant was because outside a specific frequency of the externally applied field, the electronic exchange between $\text{Fe}^{3+} \leftrightarrow \text{Fe}^{2+}$ ions does not appear. A higher value of the dielectric constant at lower frequencies is because of the inhomogeneous dielectric structure in the ferrite materials. The inhomogeneities present in the material can be oxygen vacancies, grain boundary defects, dislocations, high concentration of Fe^{2+} ions, and porosity. The substitution of Cr^{3+} in nickel ferrite increases the gathering of charges at the grain limits, and consequently, the dielectric constant decreases.⁷⁶ The Cr^{3+} ion substitution in nickel ferrite for Fe^{3+} ions was effective in decreasing the dielectric loss (ϵ''), as shown in Fig. 11(b). According to the free electron theory, the dielectric loss primarily originates from the conductive loss, and the tested ϵ'' value will decrease with the increasing frequency.⁷⁷ Fig. 11(b) also shows that the pure nickel ferrite thin-film sample possesses

a significant value of the dielectric loss, which diminishes from $x = 0.2$ to $x = 1.0$ with the increasing Cr^{3+} substitution. This behaviour demonstrates the loss in energy at the higher frequencies and thus prepared NCF samples are promising for high-frequency electronic device applications. Fig. 11(c) demonstrates the variation of the dielectric loss tangent ($\tan \delta$) as a function of frequency estimated at 300 K. The $\tan \delta$ value diminishes with the increasing frequency, which can be clarified by the 'Koop's model'.^{78,79} The estimation of loss tangent depends on various factors, for instance, the presence of Fe^{2+} ions and homogeneity of the NCF samples, which relies upon the deposition and annealing temperatures.

4. Conclusions

Herein, the TGA-DTA data confirmed the thermal behavior of the typical thin-film samples of Ni-Cr ferrite. XRD patterns demonstrated the development of single-phase cubic structure in all the prepared samples with nanocrystalline nature. Raman spectra show tetra and octa sites in the structure of



NiFe_{2-x}Cr_xO₄ and suggest the substitution of Cr³⁺ ions and displacement of Ni²⁺ particles to the tetrahedral site. The studies conducted by the FE-SEM technique revealed the development of grains with a spherical structure, agglomerated configuration, and grain size in the range of 26.65–42.14 nm. The results of the elemental analysis performed by EDAX are in close agreement with the projected composition obtained from the stoichiometry of the initial compositions used for the synthesis. The photoluminescence spectra revealed their combination phenomena belonging to semiconductor materials, indicating intrinsic bandgap defect states in the prepared ferrite thin films. The DC electrical resistivity decreases as the temperature increases, implying the semiconducting behavior of the fabricated NCF thin films. In addition, the DC electrical resistivity was observed to be enhanced with an increase in the Cr³⁺ ion substitution. All the dielectric parameters decline with an increase in frequency, corresponding to the Verwey and Bohr's model. The obtained outcomes pave the way for the applicability of the fabricated thin films in high-frequency electronic devices.

Conflicts of interest

There are no conflicts to declare.

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